

# **Glass Passivated Fast Recovery Rectifier**

#### **FEATURES**

- Glass passivated chip junction
- High current capability, Low V<sub>F</sub>
- High reliability
- High surge current capability
- Low power loss, high efficiency
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

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- Switching mode power supply (SMPS)
- Adapters
- TV
- Monitor

### **MECHANICAL DATA**

- Case: DO-204AL (DO-41)
- Molding compound meets UL 94V-0 flammability rating
- Packing code with suffix "G" means green compound (halogen-free)
- Terminal: Pure tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- Polarity: As marked
- Weight: 0.33 g (approximately)

KEY PARAMETERS						
PARAMETER VALUE UNIT						
I <sub>F(AV)</sub>	1	Α				
$V_{RRM}$	400 - 1000	V				
I <sub>FSM</sub>	30	Α				
$T_{JMAX}$	150	°C				
Package	DO-204AL (DO-41)					
Configuration Single Die						





DO-204AL (DO-41)

ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)							
PARAMETER	SYMBOL	BA157G-K	BA158G-K	BA159G-K	UNIT		
Marking code on the device		BA157G	BA158G	BA159G			
Repetitive peak reverse voltage	$V_{RRM}$	400	600	1000	V		
Reverse voltage, total rms value	$V_{R(RMS)}$	280	420	700	V		
Maximum DC blocking voltage	$V_{DC}$	400	600	1000	V		
Forward current	I <sub>F(AV)</sub>	1			Α		
Surge peak forward current, 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>		30		А		
Junction temperature	TJ	- 55 to +150		°C			
Storage temperature	T <sub>STG</sub>	- 55 to +150			°C		

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THERMAL PERFORMANCE							
PARAMETER	SYMBOL	LIMIT	UNIT				
Junction-to-ambient thermal resistance	R <sub>eJA</sub>	60	°C/W				

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)						
PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT	
Forward voltage per diode (1)	I <sub>F</sub> = 1A,T <sub>J</sub> = 25°C	V <sub>F</sub>	-	1.3	V	
Devenue autorit © reted V reading (2)	T <sub>J</sub> = 25°C		-	5	μA	
Reverse current @ rated V <sub>R</sub> per diode <sup>(2)</sup>	T <sub>J</sub> = 125°C	I <sub>R</sub>	-	100	μA	
Junction capacitance	1 MHz, V <sub>R</sub> =4.0V	CJ	15	-	pF	
Reverse recovery time	I <sub>F</sub> =0.5A , I <sub>R</sub> =1.0A I <sub>RR</sub> =0.25A	t <sub>rr</sub>	_	500	ns	

### Notes:

- 1. Pulse test with PW=0.3 ms
- 2. Pulse test with PW=30 ms

RDERING INFORMATION						
PART NO.	PACKING CODE	PACKING CODE SUFFIX	PACKAGE	PACKING		
	A0		DO-41	3,000 / Ammo box (52mm taping)		
BA15xG-K	R0	G	DO-41	5,000 / 13" Paper reel		
(Note 1, 2)	R1		DO-41	5,000 / 13" Paper reel (Reverse)		
	В0		DO-41	1,000 / Bulk packing		

### Notes:

- 1. "x" defines voltage from 400V (BA157G-K) to 1000V (BA159G-K)
- 2. Whole series with green compound (halogen-free)

EXAMPLE P/N						
EXAMPLE P/N	PART NO.	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION		
BA157G-K A0G	BA157G-K	A0	G	Green compound		



## **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

Fig1. Forward Current Derating Curve

Fig2. Typical Junction Capacitance

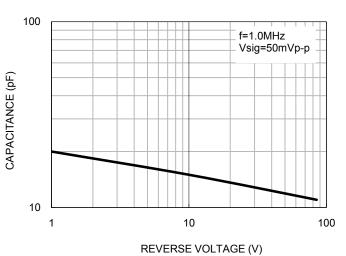


Fig3. Typical Reverse Characteristics

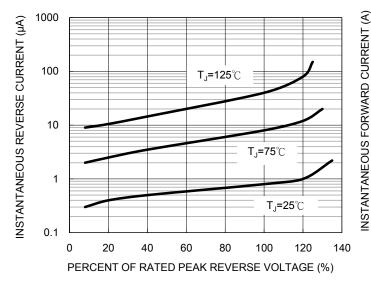
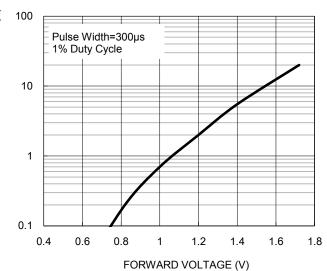


Fig4. Typical Forward Characteristics



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Fig5. Maximum Non-repetitive Forward Surge Current

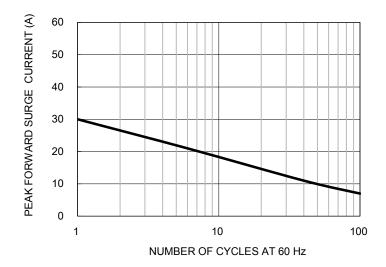
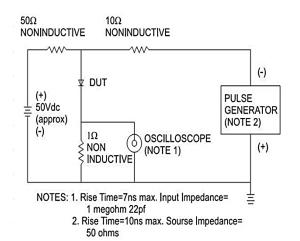
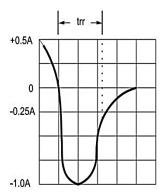


Fig6. Reverse Recovery Time Characteristic And Test Circuit Diagram

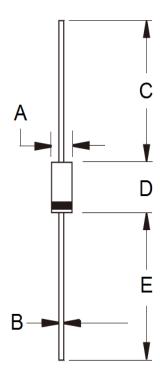






## **PACKAGE OUTLINE DIMENSIONS**

DO-204AL (DO-41)



DIM.	Unit (ı	mm)	Unit (inch)		
DIN.	Min	Max	Min	Max	
Α	2.00	2.70	0.079	0.106	
В	0.71	0.86	0.028	0.034	
С	25.40	-	1.000	-	
D	4.20	5.20	0.165	0.205	
E	25.40	-	1.000	-	

## **MARKING DIAGRAM**



= Marking Code= Green Compound P/N G YWW = Date Code = Factory Code

Version:A1701

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